Electrodeposition of Large Area, Angle-Insensitive Multilayered Structural Colors

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Abstract: We demonstrate structural colors produced by a simple, inexpensive, and non-toxic electrochemical process. Asymmetric metal-dielectric-metal multilayered structures were achieved by sequential electrodeposition of smooth gold, thin cuprous oxide, and finally thin Au on conductive substrates, forming an effective optical cavity with angle-insensitive characteristics. Different colors of high brightness were achieved by simply tuning the thickness of the electrodeposited middle cavity layer. This process is compatible with highly non-planar substrates of arbitrary shape, size and roughness. This work is the first demonstration of solution-processed, electrodeposited metal-dielectric-metal film stacks and highlights the clear advantages of this approach over traditional deposition or assembly methods for preparing colored films.

Keywords: structural colors; electrodeposition; nanocavities; thin films; angular insensitivity.
**Introduction**

Color filters that selectively transmit or reflect visible light are highly desired in a wide variety of applications, including optical displays,\textsuperscript{1,2} colored printings,\textsuperscript{3-5} aesthetic decorations,\textsuperscript{6,7} and energy harvesting.\textsuperscript{8-13} Structural colors based on optical resonance effect have attracted much attention. As compared with traditional colorant-based pigmentation, structural colors offer the advantage of high brightness, ultra-compactness, easy manufacturability, and long-term stability.\textsuperscript{14} Many schemes based on plasmonic or guide-mode resonances have been proposed for color generation.\textsuperscript{4,15-18} However, most of the structural colors demonstrated to date involve complex patterns or expensive fabrication processes, which limits high volume production. In comparison simple 1D layered structural colors made by vacuum deposition provide one possible approach for mass-production.\textsuperscript{7,19-21} Roll-to-roll vacuum deposition methods have been developed for obtaining pigment flakes exhibiting unique metallic appearance with high purity for decorative paints and colored solar cells,\textsuperscript{22} however these methods carry a high cost associated with having to rely on vacuum deposition systems.

Approaches that produce high quality thin-films at ambient conditions are thus highly desirable. Three-dimensional (3D) photonic crystals employing self-assembled nanoparticles to generate colors have been explored.\textsuperscript{23-28} However, the color properties of pigment flakes made by nanoparticle assemblies for decorative paints are compromised by disorder and disassembly during the necessary grinding steps to obtain dispersible flakes.
In comparison, electrochemical methods can be simultaneously performed under mild conditions and with the unique advantage of being applicable to objects of arbitrary shape and size. Electrodeposition specifically affords conformal film coatings on substrates with both micro- and macro-roughness\textsuperscript{29-31} since film nucleation\textsuperscript{32,33} and growth rate are readily controllable in real-time by regulation of the applied potential/current.

In this work, we present data describing a simple and inexpensive procedure for the fabrication of structural color filters at ambient conditions and $T \leq 50$ °C using electrodeposition of gold (Au) and cuprous oxide (Cu$_2$O). As a demonstration, electrodeposition of tri-layer asymmetric metal/dielectric/metal (MDM) Fabry-Pérot (F-P) cavities is shown, producing bright reflective colors. Here, we constrain the thickness of both the top thin and the bottom Au films and adjust solely the thickness of the Cu$_2$O layers to obtain different colors of high brightness. Unlike simple structural color films based upon uncapped oxide films\textsuperscript{34-36} the MDM structures demonstrated here show several fundamental and practical advantages. First, due to the high refractive index of Cu$_2$O, the color of the resultant electrodeposited MDM films is angle-insensitive at viewing angles up to ± 60°. Second, the electrodeposition method shown here produces MDM structural colors across the CMY color space with superior brightness. In fact, the successful electrodeposition of uniformly thin metal layers on a dielectric substrate over macroscopic dimensions, which directly results into the high brightness of generated colors, is one of the primary achievements in this work. Third, the electrodeposition process is comparatively rapid, performed without expensive
ancillary process equipment, and compatible with irregular, curved substrates. Specifically, a fully aqueous, non-toxic electrolyte is utilized that is free of any harmful pollutants. Fourth, the films are strongly adherent on stainless steel substrates. The suitability of the presented electrodeposition strategy to prepare structural colors and directly on arbitrary size and shaped conductive surfaces, with the capacity for scaling up is discussed. This facile and inexpensive method may potentially lead to extensive uses of structural colors in diverse applications, including solar cells, color displays, and aesthetic decorations, at a lower cost.

**Results and Discussion**

Figure 1a illustrates the schematic of the electrodeposition process for layered optical films in the form of Au/Cu$_2$O/Au tri-layer MDM stacks deposited on a heavily n-doped crystalline silicon (Si) substrate. The electrodeposition was performed using a standard three-electrode electrochemical cell design (Figure 1b). Here the conductive n$^+$-Si substrates and a platinum mesh were used as the working and counter electrodes, respectively, while suitable reference electrodes were used for the three-electrode electrochemical cell setup. Further details on the setup are listed in the Methods Section. For electrodeposition of MDM structural colors on flat surfaces, hydrogen-terminated crystalline n$^+$-Si (111) substrates with a small miscut angle ($\pm 0.5^\circ$) were specifically employed to improve the uniformity of the first Au layer.$^{37}$

The thicknesses of the bottom Au reflector was 40 nm, while the top Au layer was set to 15 nm. Different colors can be obtained by varying the Cu$_2$O cavity layer
thickness, which determines the F-P cavity resonances to enhance the absorption by the top Au layer at discrete wavelengths. For example, pure cyan, magenta, and yellow (CMY) film colors were realized with electrodeposited Cu₂O thicknesses of 70, 45, and 20 nm, respectively. The measured reflectance spectra in Figure 1c (dashed curves) of the CMY colored devices agreed very well with predictions from optical simulations of the respective MDM structures (solid curves) based on the transfer matrix method with the refractive indices and thicknesses of electrodeposited Au and Cu₂O layers determined by spectroscopic ellipsometry. The insets in Figure 1c illustrate the colors of the fabricated devices as viewed from 0° with respect to the surface normal.

Figure 2a shows the refractive indices \( n \) and \( k \) (the real and imaginary parts of the refractive index, respectively) of the electrodeposited Au and Cu₂O films. Both data sets are generally in agreement with data recorded for Au and Cu₂O films prepared by vacuum-based deposition methods. The refractive index of the reference Au was characterized using Au films grown in our own lab by e-beam evaporation and the reference data for reactively-sputtered Cu₂O was extracted from Ref. [39]. Accordingly, these measurements illustrate the high quality optical properties of these films despite being prepared entirely from aqueous solution. Even the measurably smaller \( n \) for electrodeposited Cu₂O as compared to that for Cu₂O bulk standards resulted in the need for only slightly thicker Cu₂O layers to generate a reflectance dip at a given wavelength and to realize functional cavity layers for a given color. Figure 2b provides the net phase shift calculated using the measured refractive indices, which includes two reflection phases at both the top and bottom interfaces and the
accumulated propagation phase within the Cu$_2$O layer for the three CMY MDM films. These data clearly indicate the absorption resonances ($\lambda=$458 nm for yellow, $\lambda=$531 nm for magenta, and $\lambda=$618 nm for cyan, where the net phase shift is equal to a multiple of $2\pi$) that selectively absorb light in the visible range for the reflective color generation, and are in agreement with the reflectance dips seen in Figure 1c.

Since high smoothness and uniformity are required to obtain highly reflective structural colors, appropriate care must be taken to ensure low surface roughness of these electrodeposited films. The first Au layer was deposited following an approach developed for electrodeposition of flat Au on Si(111) with an aqueous solution containing 0.1 mM HAuCl$_4$•3H$_2$O, 1 mM KCl, 1 mM H$_2$SO$_4$ and 100 mM K$_2$SO$_4$, adapted following separate reports suggesting lower electrodeposition roughness with Si (111) substrates with small miscut angles.$^{37,41,42}$ Electrodeposition of this Au layer was performed potentiostatically at $E = -1.9$ V vs. $E$(Ag/AgCl). Au film growth rates of $\sim$1 nm min$^{-1}$ were determined from the as-deposited films using spectroscopic ellipsometry and cross-sectional scanning electron microscopy (SEM). Faster growth rates at this potential were possible by increasing the concentration of HAuCl$_4$•3H$_2$O if the pH was separately maintained. Figure 3a shows atomic force microscopy (AFM) measurements of a 40 nm thick Au film uniformly electrodeposited on a n$^+$-Si(111) substrate. The root-mean-square roughness ($R_{RMS}$) was measured to be $\sim$1.4 nm.

The electrodeposition of Cu$_2$O on these Au films was performed galvanostatically in an alkaline solution where Cu(II) hydroxypropane-1,2,3-tricarboxylate (i.e. copper citrate) was generated by addition of 0.4 M CuSO$_4$•5H$_2$O and 1.6 M citric acid
The applied cathodic current density, \( j \), dictated whether \( \text{Cu}_2\text{O} \) \( (j = 0.1 \text{ mA cm}^{-2}) \) or \( \text{Cu} \) \( (j \geq 1 \text{ mA cm}^{-2}) \) was produced.\(^{44}\)

\[
\text{[Cu}_2(\text{C}_6\text{H}_4\text{O}_7)\text{]}^+ + 2\text{e}^- + \text{H}_2\text{O} \rightarrow \text{Cu}_2\text{O} + 2\text{C}_6\text{H}_4\text{O}_6\text{OH}^3^- \tag{1}
\]

\[
\text{[Cu}_2(\text{C}_6\text{H}_4\text{O}_7)\text{]}^{4+} + 4\text{e}^- + 2\text{H}_2\text{O} \rightarrow 2\text{Cu} + 2\text{C}_6\text{H}_4\text{O}_6\text{OH}^3^- + 2\text{OH}^- \tag{2}
\]

Care was taken to avoid producing any \( \text{Cu}^0 \) in the \( \text{Cu}_2\text{O} \) films. A solution temperature of 50 °C and \( \text{pH} \) – 10.9 were employed. \( \text{Cu}_2\text{O} \) electrodeposition rates ranging from 0.05 – 0.1 nm s\(^{-1}\) were observed. Representative chronopotentiometry plots for three different thicknesses of electrodeposited \( \text{Cu}_2\text{O} \) are presented in the Supporting Information (Figure S1), highlighting both the repeatability of electrodepositions and the ability to readily use time as the sole variable to determine thickness. AFM measurements of a 45 nm thick \( \text{Cu}_2\text{O} \) film (used for the magenta device) electrodeposited on the same Au film in Figure 3a are shown in Figure 3b. The \( R_{\text{RMS}} \) was slightly larger (4.2 nm) but nonetheless more than low enough to maintain a mirror-like appearance.

The electrodeposition of a thin metal layer of good optical quality on top of a dielectric was the most challenging. For example, the intent to use the same bath for the \( \text{Cu}_2\text{O} \) electrodeposition and just grow a capping \( \text{Cu}^0 \) layer\(^{43,45-48}\) failed to produce smooth Cu with good optical property (details see Figure S2). Electrodeposition of the top metal layer required satisfying several constraints: uniformity over large areas while maintaining minimal thickness (i.e. < 20 nm), low surface roughness to avoid deleterious light scattering effects, and not compromising the physical and chemical integrity of the underlying \( \text{Cu}_2\text{O} \). Specifically, either chemical etching of \( \text{Cu}_2\text{O} \) or
partial reduction of Cu sites that perturbs film stoichiometry during top metal electrodeposition would compromise the optical quality of the MDM structures. As an alternative, Au films were again electrodeposited using the same stock solution that was prepared for the bottom Au electrodeposition, however a radically different methodology than that used for the underlying Au film was necessary. Cu$_2$O is more chemically stable in alkaline solutions and will not reduce to Cu$^0$ so long as the potential is not made more negative than approximately -0.5 V vs. $E$(Ag/AgCl) (for pH ~ 11). For these reasons, the pH of the stock solution was increased to ~ 10-11. In this solution at $T = 50$ °C, Au electrodeposition was possible over a wide potential range (-2.06 $< E < -0.52$ V vs. $E$(Ag/AgCl)). Still, electrodepositions performed at $E < -1.05$ V vs. $E$(Ag/AgCl) on the Au/Cu$_2$O MD stack resulted in peeling off due to H$_2$ bubbles from concurrent proton reduction process. Accordingly, the top Au layer was specifically electrodeposited at $E = -0.52$ V vs. $E$(Ag/AgCl) and $T = 50$ °C with constant solution convection. These factors ensured the underlying Cu$_2$O films were not compromised. AFM measurements of the final MDM structures are provided in Figure 3c. The overall roughness of the MDM stack is not significantly increased on electrodeposition of the 15 nm thick top Au film, as can be seen from the $R_{RMS} (= 5.3$ nm) and $R_a (= 3.5$ nm) values. Although some larger Au aggregates (100 nm wide, 30 nm thick) suggestive of sporadic 3D film growth were observed, the overall macroscopic uniformity and regularity of these films yielded reflectance spectra very similar to responses predicted for the ideal flat slab film stacks (Figure 1). The SEM image in Figure 3d presents a cross-section image of a magenta colored MDM stack. The average thickness of the
individual layers in this tri-layer stack match the intended thicknesses for each layer that were optimized using optical simulations. Both the small degree of thickness variation during electrodeposition and the surface roughness of electrodeposited films lead to the slight discrepancy between the measured and simulated reflectance spectra as seen in Figure 1c.

The angle-resolved reflectance for electrodeposited Au/Cu$_2$O/Au MDM stacks measured using unpolarized light are presented in Figures 4a-c. The measured spectra agree well with the model predictions for the angle-resolved reflectance of ideal Au/Cu$_2$O/Au MDM stacks shown in Figures 4d-f. Owing to the high refractive index of the Cu$_2$O cavity layer which elicits a very small refracted angle into the structure, the reflectance minima for the CMY colors are independent of the incident angle up to ± 60°. Figure 4g presents a set of electrodeposited CMY structural color films viewed at various angles under ambient white light. In these images, the color purity of the films is unchanged at the different viewing angles, which addresses one of the key challenges facing many structural color designs.

A final test of the unique merits of electrodeposition as methodology for MDM color films was carried out on an irregularly shaped substrate. When performed carefully, electrodeposition can yield films that follow closely the contours of any electrode shape. To demonstrate the control afforded by the cumulative process developed here, Au/Cu$_2$O/Au MDM stacks were deposited on a working electrode consisting of stainless-steel spoons. Figure 5 shows the resultant glossy and uniform color appearance of CMY colors on the curved and rough surfaces of these spoons. In
these images, the curved profile of the spoon in effect illustrates reflectance over a wide range of viewing angles. The homogeneity and consistency of the colors, in addition to the lustrous appearance, directly validate the electrodeposited MDM approach and the great uniformity in thickness of each electrodeposited layer. The uniformity of the electrodeposited films is discussed further in the Supporting Information (Figure S3). In addition, a further advantage of these electrodeposited MDM films was noted in an adhesion test. A standard peel test using adhesive tape was applied on the as-prepared MDM coatings. These MDM films remained strongly adhered to stainless steel without obvious mechanical damage.

A final note should be made regarding the specific components employed here. n+-doped Si was used in this study for easy cleaving of the sample for SEM characterization. Many other substrates can be used, as long as a conductive seed layer is provided. In principle, electrodeposition of MDM layers can be performed with a wide variety of different metal and dielectric layers. The Cu$_2$O dielectric layer represents a significant improvement in terms of safety over prior demonstrations of electrodeposited structural colors. Specifically, electrodeposited chromium oxide films have been used as interference color coatings on metal surfaces because film thicknesses up to 500 nm can be readily obtained. However, the toxicity of chromium electrolytes is substantial and such solutions are considered extremely potent pollutants. In contrast, the copper citrate solution used here is comparatively benign, closely mirroring the composition of a common colorimetric solution used to test for sugars in water. Still, it is conceivable that other dielectrics that can be readily
electrodeposited including amorphous silicon,\textsuperscript{61} titanium oxide,\textsuperscript{62} and zinc oxide\textsuperscript{63} could be used to form cavity layers in MDM structures. Doing so may facilitate the electrodeposition of other coinage metals such as Ag, Cu, and Al that would lead to similar reflectance and brightness properties.

Conclusions

In summary, we have demonstrated a novel and simple approach for generating MDM structural color films that can be performed entirely under ambient pressure and temperature conditions using a facile bench-top electrochemical set up. These structural colors are designed based on tri-layer MDM Fabry-Pérot resonators. The cavity layer (Cu$_2$O) thickness was readily tuned by electrodeposition parameters so as to generate any arbitrary CMY color. The electrodeposited films exhibit stable and angle-insensitive color, owing to the high refractive index of electrodeposited Cu$_2$O. These MDM films were strongly adherent as-prepared. This electrodeposition tactic was applied both to flat and curved substrates and is readily scalable since expensive ancillary equipment is not required. These aspects cumulatively open up new avenues for development and implementation MDM structural color films.

Methods

Chemicals and Materials. Acetone (ACS grade, Fisher Scientific), methanol (ACS grade, Fisher Scientific), 2-propanol (ACS grade, Fisher Scientific), buffered hydrofluoric acid (BHF, Transene Inc.), 49% hydrofluoric acid (HF, Transene Inc.), gold (III) chloride
trihydrate (HAuCl₄·3H₂O, >99.9% Sigma-Aldrich), potassium sulfate (K₂SO₄, ACS grade, Fisher Scientific), potassium chloride (KCl, ACS grade, Fisher Scientific), sulfuric acid (H₂SO₄, 0.1 M eluent concentrate for IC, Sigma-Aldrich), copper (II) sulfate pentahydrate (CuSO₄·5H₂O, ACS grade, Avantor), citric acid (>99.5% ACS grade, Sigma-Aldrich), sodium hydroxide (NaOH, >98% ACS grade, Sigma-Aldrich), indium (99.99%, Gallium Source), and gallium (99.999%, Alfa Aesar) were used as received. Degenerately doped n⁺-Si(111) wafers with a ± 0.5 ° miscut (0.525 ± 0.020 mm, ρ < 0.007 Ω·cm, Addison Engineering, Inc.) were diced and used as substrates. Deionized (DI) water with a resistivity >18.2 MΩ·cm was used throughout.

**Substrate preparation.** Both n⁺-Si(111) substrates and stainless-steel spoons were degreased by sequentially sonicating for five minutes each in acetone, methanol, isopropyl alcohol, and water, and then dried under a nitrogen (N₂) gas stream. H-terminated Si(111) surfaces were prepared by immersion of the Si substrates in 5% HF for 30 seconds, soaking in DI water at T = 95 °C for 20 minutes, and then etching sequentially in 5% HF and BHF for 30 seconds each. Etched Si substrates were then rinsed with water, dried under a N₂(g) stream, and were immediately used for the electrodepositions. The stainless-steel spoons were used as working electrodes directly after the initial degreasing steps without any HF etch steps.

**Electrodeposition of Au and Cu₂O.** All electrochemical depositions were performed in a three-electrode cell in lab ambient and T ≤ 50 °C. Computer controlled
potentiostats (CHI760C, CH Instruments and Solartron Analytical 1287A, AMETEK Scientific Instruments) were used throughout. A platinum mesh counter electrode was used for all electrodepositions whereas multiple reference electrodes were employed as dictated by the pH of the electrodeposition solution.

An aqueous stock solution of 0.1 mM HAuCl₄·3H₂O, 1 mM KCl, and 100 mM K₂SO₄ was prepared for Au electrodeposition. For the bottom Au film, a portion of this stock solution was separated and 1 mM H₂SO₄ was added to it to adjust the pH to ~3.37. An aqueous Ag/AgCl (sat. KCl) electrode was employed as the reference electrode for these solutions. Ohmic contact to the Si substrate was made by applying eutectic gallium-indium to the tip of the wafer and clipping the working electrode of the potentiostat to this region. For the case of stainless-steel spoons, the working electrode of the potentiostat was directly clipped on to the end of the spoon. The Si substrate was prepolarized by applying a potential of \( E = -1.9 \text{ V vs. } E(\text{Ag/AgCl}) \) and was then immersed into solution. This prepolarization step was necessary to avoid electroless plating of Au and the formation of a native oxide layer on Si that could prevent further epitaxial Au growth. A potential of \( E = -1.45 \text{ V vs. } E(\text{Ag/AgCl}) \) was selected for Au electrodeposition on the spoons in order to avoid excessive hydrogen evolution at more negative potentials (Figure S4). For all samples, electrodepositions performed for 40 minutes at \( T = 35 \degree \text{C} \) with a stirred solution yielded uniform ~ 40 nm thick Au films.

Cu₂O was electrodeposited from alkaline Cu(II)-citrate solutions, as has been demonstrated previously.⁴³ An aqueous solution of 0.4 M CuSO₄·5H₂O and 1.6 M citric acid was prepared and NaOH was slowly added to this solution to raise the pH to ~10.9.
A mercury sulfate (sat. K$_2$SO$_4$) electrode was employed as the reference electrode in the three-electrode cell, but all stated potentials are reported with respect to $E$(Ag/AgCl). Kapton tape was used to define the total active area of these working electrodes in contact with the solution. The cathodic current density during the electrodeposition was tuned between 0.05 to 0.1 mA cm$^{-2}$ to ensure the potential measured during electrodeposition did not exceed $E = -0.41$ V vs. $E$(Ag/AgCl). Electrodepositions performed at $T = 50$ °C and under convection resulted in uniform Cu$_2$O electrodeposition ($\sim 0.05 – 0.1$ nm s$^{-1}$) and a measured potential of $E = -0.16$ V to -0.41 V vs. $E$(Ag/AgCl).

For the electrodeposition of the top Au layer, an alkaline solution was utilized to prevent compromising the Cu$_2$O layer. A portion of the stock Au solution prepared above was separated and its pH was adjusted to $\sim 10-11$ by addition of NaOH. A mercury sulfate (sat. K$_2$SO$_4$) reference electrode was employed. Top Au layers with thicknesses of approximately 15 nm were electrodeposited at $E = -0.52$ V vs. $E$(Ag/AgCl) at $T = 50$ °C under convection for 30 minutes.

**Optical Simulations.** Simulated reflectance spectra and the net phase shifts within the Cu$_2$O layer were calculated based on the transfer matrix method. These simulations used measured refractive indices from a spectroscopic ellipsometer (M-2000, J. A. Woollam Co.) as inputs.
**MDM film characterization.** Reflectance spectra at normal incidence were measured using a thin-film measurement instrument (F20, Filmetrics) integrated with a spectrometer and a white light source. Angle-resolved reflectance spectra of as-prepared MDM stacks and determination of the thickness of each layer were performed with a spectroscopic ellipsometer (M-2000, J. A. Woollam Co.). The smallest incident angle measurable with this instrument was 45°. Thus, the measured spectra in Figure 4 has an angular range of 45° to 60°. Reflectance spectra simulations for 0° to 60° viewing angles are reported to illustrate the wide range of angle insensitivity for our structural colors (Figure 4d-f). Cross-sectional scanning electron microscopy was performed with a SU8000 FE-SEM (Hitachi High-Technologies Corporation) with a Schottky field emitter operated at 5 keV beam voltage. The surface morphology of each layer was investigated by tapping mode atomic force microscopy (TESPA-V2 tip and Dimension Icon AFM, Bruker Corporation).

**Supporting Information**

The Supporting Information is available free of charge on the ACS Publications website at DOI: ….

**Chronopotentiometry Plots for Cu2O electrodeposition; Issues Related to Electrodeposited Cu; Thickness Uniformity of Electrodeposited Films; Cyclic Voltammetry response for Si and stainless-steel spoon electrode in Au electrodeposition solution**
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